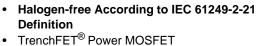


MCH3409-TL-VB Datasheet

N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
	0.036 at V _{GS} = 10 V	4				
20	0.040 at V _{GS} = 4.5 V	3.8	4 nC			
	0.048 at V _{GS} = 2.5 V	3.6				





COMPLIANT HALOGEN

FREE

- 100 % R_a Tested

FEATURES

Compliant to RoHS Directive 2002/95/EC

SOT-323 SC-70 (3-LEADS) 3 D Top View

APPLICATIONS

- Portable Devices
 - Load Switch
 - Battery Switch
- · Load Switch for Motors, Relays and Solenoids

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unl	ess otherwis	se noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	20	V	
Gate-Source Voltage		V_{GS}	± 12	V	
	T _C = 25 °C		4 ^a		
Continuous Proin Current (T. – 150 °C)	T _C = 70 °C	1 .	3.6 ^a		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	l _D	4 ^{a, b, c}		
	T _A = 70 °C		3.7 ^{b, c}	A	
Pulsed Drain Current (t = 300 μs)		I _{DM}	20		
Continuous Source-Drain Diode Current	T _C = 25 °C	ı	2.3 ^a		
Continuous Source-Diain Diode Current	T _A = 25 °C	I _S	1.3 ^{b, c}		
	T _C = 25 °C		2.8		
Maximum Power Discipation	T _C = 70 °C	В	1.8	W	
Maximum Power Dissipation	T _A = 25 °C	P _D	1.56 ^{b, c}	VV	
	T _A = 70 °C		1.0 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	60	80	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	34	45	C/VV		

Notes:

- a. Package limited, $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 125 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•			•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250 A		23		mV/°(
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 3.2		mv/·C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 0.5	μΑ
Gate-Gource Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 25	
Zero Gate Voltage Drain Current	1	V _{DS} = 20 V, V _{GS} = 0 V			1	
Zero Gate voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	15			Α
		$V_{GS} = 10 \text{ V}, I_D = 3.7 \text{ A}$		0.036		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 3.6 \text{ A}$		0.040		Ω
		V _{GS} = 2.5 V, I _D = 1.5 A		0.048		
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 3.7 A		17		S
Dynamic ^b						
Total Gate Charge	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.7 \text{ A}$		8.8	13.5	nC
Total Gate Charge	Qg			4	6	
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3.7 \text{ A}$		0.9		
Gate-Drain Charge	Q_{gd}			1.1		
Gate Resistance	R_g	f = 1 MHz	0.4	2	4	kΩ
Turn-On Delay Time	t _{d(on)}			0.29	0.58	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 4.1 \Omega$		0.4	8.0	
Turn-Off DelayTime	t _{d(off)}	$I_D \approx 3.7 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		1.9	3.8	
Fall Time	t _f			0.75	1.5	110
Turn-On Delay Time	t _{d(on)}			0.1	0.2	μs
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 4.1 \Omega$		0.15	0.3	
Turn-Off DelayTime	t _{d(off)}	$I_D \approx 3.7 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		3	6	
Fall Time	t _f			0.75	1.5	
Drain-Source Body Diode Characteristi	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.3	А
Pulse Diode Forward Current	I _{SM}				20	
Body Diode Voltage	V_{SD}	$I_S = 3.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.85	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			12	25	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 3.7 A, dl/dt = 100 A/μs, T _J = 25 °C		5	10	nC
Reverse Recovery Fall Time	t _a	i _F = 3.7 A, αι/αι = 100 Αγμ5, 1 _J = 25 C		6.5		ne
Reverse Recovery Rise Time t _b				5.5		ns

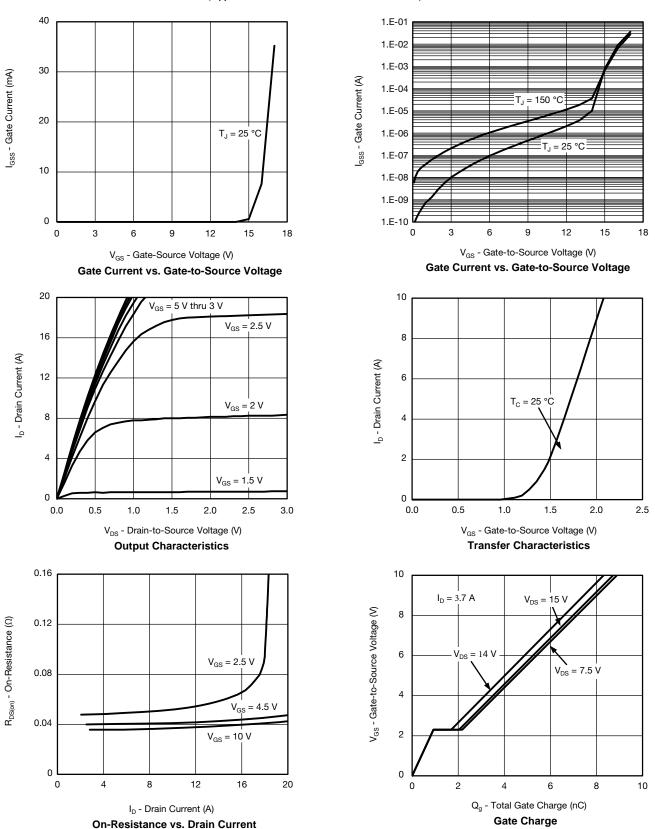
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

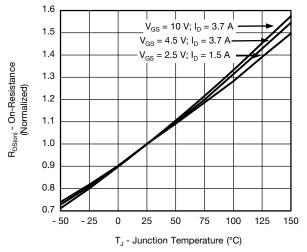


TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

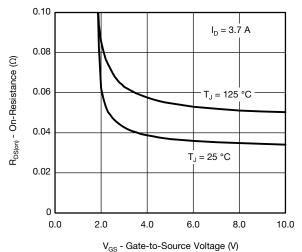




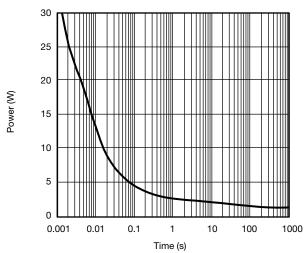
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



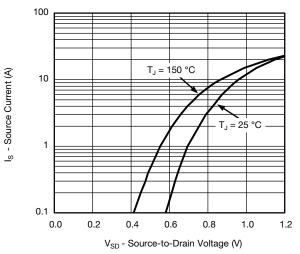
Normalized On-Resistance vs. Junction Temperature



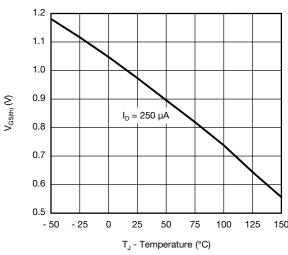
On-Resistance vs. Gate-to-Source Voltage



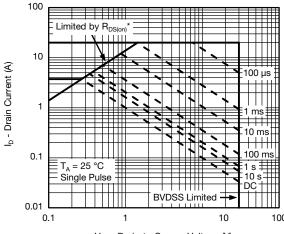
Single Pulse Power, Junction-to-Ambient



Source-Drain Diode Forward Voltage



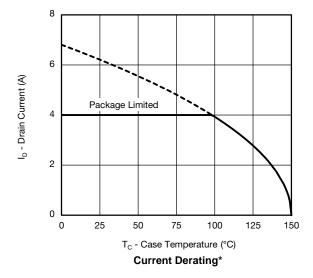
Threshold Voltage

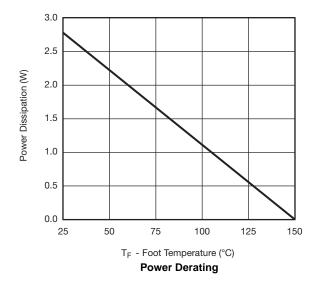


$$\begin{split} &V_{DS}\text{ - Drain-to-Source Voltage (V)}\\ ^*V_{GS}>&\min\text{mum }V_{GS}\text{ at which }R_{DS(on)}\text{ is specified}\\ \textbf{Safe Operating Area, Junction-to-Ambient} \end{split}$$



TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

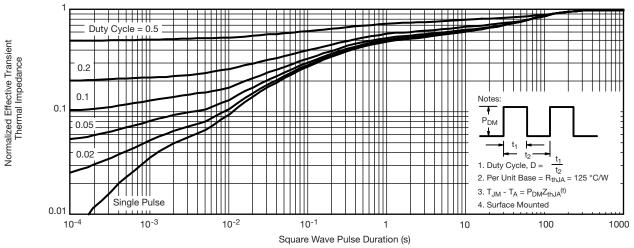




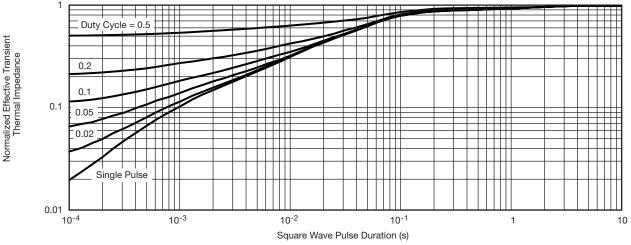
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



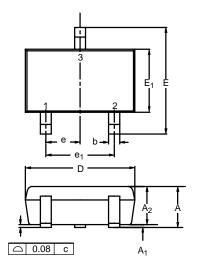
Normalized Thermal Transient Impedance, Junction-to-Ambient

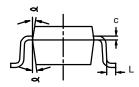


Normalized Thermal Transient Impedance, Junction-to-Foot



SC-70: 3-LEADS



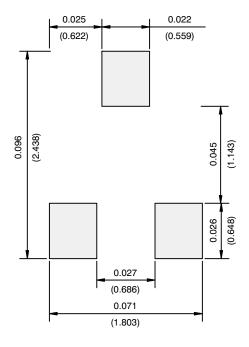


	MIL	LIMET	ERS	INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.90	_	1.10	0.035	_	0.043
A ₁	1	_	0.10	_	_	0.004
A ₂	0.80	_	1.00	0.031	_	0.039
b	0.25	_	0.40	0.010	_	0.016
С	0.10	_	0.25	0.004	_	0.010
D	1.80	2.00	2.20	0.071	0.079	0.087
Е	1.80	2.10	2.40	0.071	0.083	0.094
E ₁	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65BSC			0.026BSC		
e ₁	1.20	1.30	1.40	0.047	0.051	0.055
L	0.10	0.20	0.30	0.004	0.008	0.012
٦	7°Nom			7°Nom		

DWG: 5549



RECOMMENDED MINIMUM PADS FOR SC-70: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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